

General Description

The WST2314 is the highest performance trench N-ch MOSFET with extreme high cell density , which provide excellent RDSON and gate charge for most of the small power switching and load switch applications.

The WST2314 meet the RoHS and Green Product requirement with full function reliability approved.

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent Cdv/dt effect decline
- Green Device Available

Product Summery

BVDSS	RDSON	ID
20V	26mΩ	5.5A

Applications

- High Frequency Point-of-Load Synchronous Small power switching for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch

SOT-23-3L Pin Configuration



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units	
V _{DS}	Drain-Source Voltage	20	V	
V _{GS}	Gate-Source Voltage	±12	V	
I _D @T _C =25℃	Continuous Drain Current, V _{GS} @ 4.5V ¹	5.5	А	
I₀@T₀=70℃	Continuous Drain Current, V _{GS} @ 4.5V ¹	4.5	А	
I _{DM}	Pulsed Drain Current ²	20	А	
P _D @T _A =25℃	Total Power Dissipation ³	1.2	W	
T _{STG}	Storage Temperature Range -55 to 150		°C	
TJ	Operating Junction Temperature Range	-55 to 150	°C	

Thermal Data

Symbol	Parameter	Тур.	Max.	Unit
R _{θJA}	Thermal Resistance Junction-ambient ¹		125	°C/W
R _{θJC}	Thermal Resistance Junction-Case ¹		85	°C/W



N-Channel MOSFET

Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V_{GS} =0V , I _D =250uA	20			V
∆BV _{DSS} /∆T _J	BVDSS Temperature Coefficient	Reference to 25 $^\circ\!\mathrm{C}$, $I_D\text{=}1\text{mA}$		0.022		V/℃
	Static Drain-Source On-Resistance ²	V _{GS} =4.5V , I _D =4A		26	32	mΩ
R _{DS(ON)}		V _{GS} =2.5V , I _D =3A		40	48	
V _{GS(th)}	Gate Threshold Voltage		0.5	0.7	1.4	V
$ riangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	$-V_{GS}=V_{DS}$, $I_D=250 uA$		-2.33		mV/℃
1	Drain-Source Leakage Current	V_{DS} =16V , V_{GS} =0V , T _J =25 $^{\circ}$ C			1	
I _{DSS}		V _{DS} =16V , V _{GS} =0V , T _J =55℃			5	uA
I _{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm12V$, $V_{DS}=0V$			±100	nA
gfs	Forward Transconductance	V _{DS} =5V , I _D =5A		18		S
R _g	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		1.5	3	Ω
Qg	Total Gate Charge (4.5V)	V _{DS} =15V , V _{GS} =4.5V , I _D =5A		9.5	13	nC
Q _{gs}	Gate-Source Charge			1.6	2.0	
Q _{gd}	Gate-Drain Charge			3.0	3.8	
T _{d(on)}	Turn-On Delay Time	V _{DD} =10V , V _{GS} =4.5V , R _G =6.0Ω I _D =5A		3.3	8.2	
Tr	Rise Time			4.6	10	1
T _{d(off)}	Turn-Off Delay Time			25	42	ns
T _f	Fall Time			4.0	7.2	
C _{iss}	Input Capacitance	V _{DS} =15V , V _{GS} =0V , f=1MHz		854		
C _{oss}	Output Capacitance			95		pF
Crss	Reverse Transfer Capacitance			69]

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current ^{1,4}				5.5	А
I _{SM}	Pulsed Source Current ^{2,4}	$V_G = V_D = 0V$, Force Current			20	А
V _{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =1A , T _J =25℃			1.2	V
t _{rr}	Reverse Recovery Time			14.5	25	nS
Qrr	Reverse Recovery Charge	l ⊧=5A , dl/dt=100A/µs , T _J =25℃		8.4	14	nC

Note :

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper,t<10sec.

2.The data tested by pulsed , pulse width $\,\leq\,$ 300us , duty cycle $\,\leq\,$ 2%

3.The power dissipation is limited by 150 $^\circ\!\mathrm{C}$ junction temperature

4. The data is theoretically the same as I_D and I_{DM} , in real applications , should be limited by total power dissipation.



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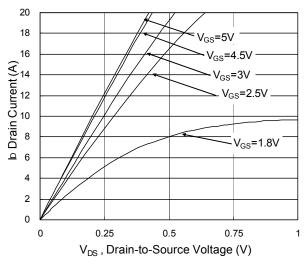


Fig.1 Typical Output Characteristics

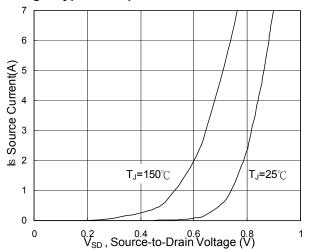


Fig.3 Forward Characteristics Of Reverse

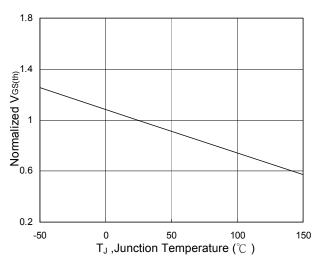


Fig.5 Normalized $V_{GS(th)}$ vs. T_J

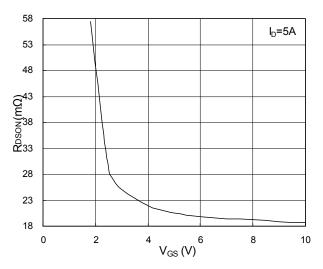


Fig.2 On-Resistance vs. Gate-Source

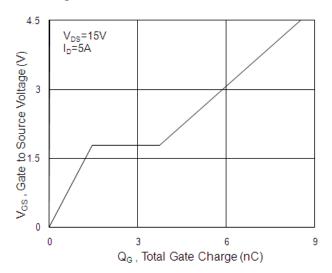


Fig.4 Gate-Charge Characteristics

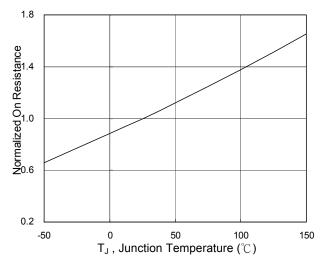


Fig.6 Normalized R_{DSON} vs. T_{J}



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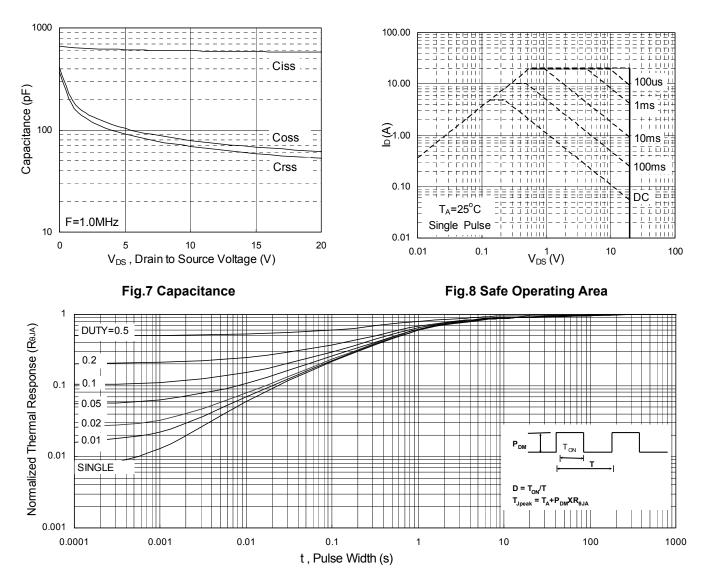
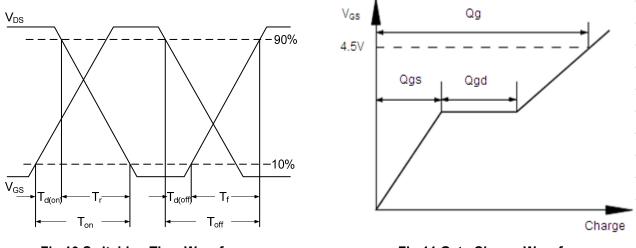


Fig.9 Normalized Maximum Transient Thermal Impedance









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